1A,2V-6V Input,1.5MHz Synchronous Step-Down LED Driver

FEATURES

- **1.5MHz Constant Frequency Operation**
- **1A Output Current**
- **No Schottky Diode Required**
- **2V to 6V Input Voltage Range**
- **Feedback Voltage 0.1V**
- **100% Duty Cycle in Dropout Operation**
- **Low Quiescent Current: 10μA**
- **Short Circuit Protection**
- **Thermal Fault Protection**
- **Inrush Current Limit and Soft Start**
- **<1μA Shutdown Current**
- **SOT23-5 package**

APPLICATIONS

- **LED Drivers**

GENERAL DESCRIPTION

The MT3401 is a constant frequency, current mode step-down LED Drivers.

The device integrates a main switch and a synchronous rectifier for high efficiency without an external Schottky diode.

The MT3401 can also run at 100% duty cycle for low dropout operation.

This device offers two operation modes, PWM control and PFM Mode switching control, which allows a high efficiency over the wider range of the LED current.

The MT3401 is offered in a low profile 5-pin, SOT package, and is available in an Adjustable version.

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TYPICAL APPLICATION

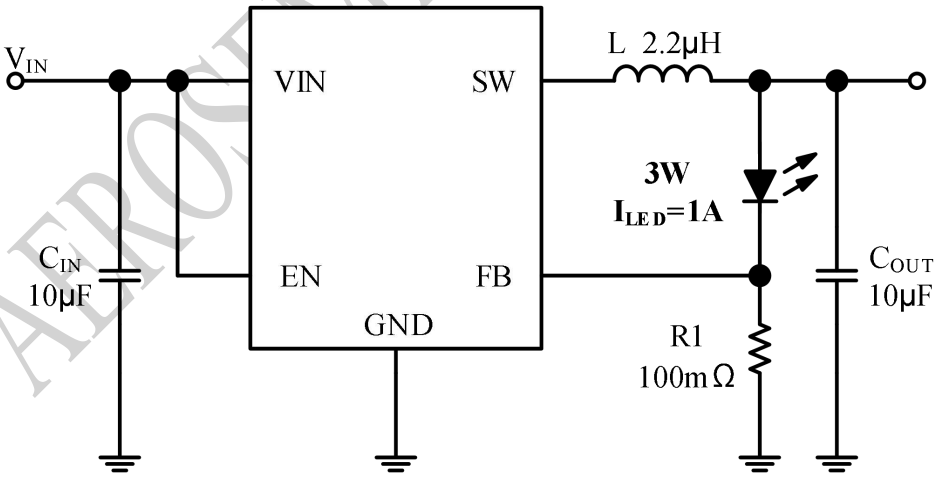


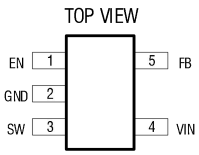
Figure 1. MT3401 Basic Application Circuit

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ABSOLUTE MAXIMUM RATINGS (Note 1)

Input Supply Voltage……..……-0.3V to 6.5V
EN,FB Voltages……..…...….-0.3V to 6.5V
SW Voltage……...-0.3V to (V_{IN}+0.3V)
Power Dissipation…….……..0.4W
Thermal Resistance θ_{JC}……..…..130°C/W
Thermal Resistance θ_{JA}……..…..250°C/W
Junction Temperature(Note2)…….……...150°C
Operating Temperature Range….-40°C to 85°C
Lead Temperature(Soldering,10s)…..…..260°C
Storage Temperature Range….-65°C to 150°C
ESD HBM(Human Body Mode)……..±2kV

PACKAGE/ORDER INFORMATION

	Order Part Number	Package	Top Marking	Packaging
	MT3401	SOT23-5	A42FYW	3k/reel

Y:Year, W:Week

PIN DESCRIPTION

Pin Name	Pin Number	Description
EN	1	Chip Enable Pin. Drive EN above 1.5V to turn on the part. Drive EN below 0.3V to turn it off. Do not leave EN floating.
GND	2	Analog ground pin.
SW	3	Power Switch Output. It is the switch node connection to Inductor. This pin connects to the drains of the internal P-ch and N-ch MOSFET switches.
VIN	4	Power Supply Input.Must be closely decoupled to GND with a 10μF or greater ceramic capacitor.
FB	5	Feedback Pin. A resistor connected between FB to GND is used to program LED current.

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ELECTRICAL CHARACTERISTICS (Note 3)

(V_{IN}=V_{EN}=3.6V, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Input Voltage Range		2		6	V
Supply Current (Quiescent)	VEN =3.0V		10	20	μA
Supply Current (Shutdown)	VEN =0		0	1	μA
Regulated Feedback Voltage V_{FB}		95	100	105	mV
Oscillation Frequency	V_{FB} =100mV		1.5		MHz
	V_{FB} =0V		300		kHz
On Resistance of PMOS	I_{SW}=100mA		300	450	mΩ
On Resistance of NMOS	I_{SW}=-100mA		300	450	mΩ
Peak Current Limit			2		A
Over Voltage Protection Threshold			6.5		V
EN High-Level Input Voltage	V_{ENH}	1.5			V
EN Low-Level Input Voltage	V_{ENL}			0.4	V
Under-Voltage Lockout Threshold	Wake up		1.9		V
	Shutdown		1.75		V
	Hysteresis		150		mV
SW Leakage Current	V_{EN}=0V,V_{IN}=V_{SW}=5.5V		±0.01	±1.0	μA
Soft Start			200		μS
Thermal Shutdown			160		℃
Thermal Hysteresis			16		℃

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: T_J is calculated from the ambient temperature T_A and power dissipation P_D according to the following formula: $T_J = T_A + (P_D)$ x (250°C/W).

Note 3: 100% production test at +25°C. Specifications over the temperature range are guaranteed by design and characterization.

Note 4: Dynamic supply current is higher due to the gate charge being delivered at the switching frequency.

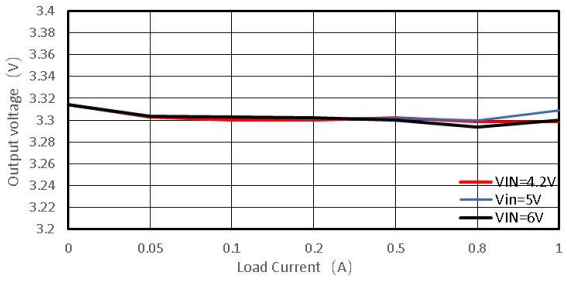
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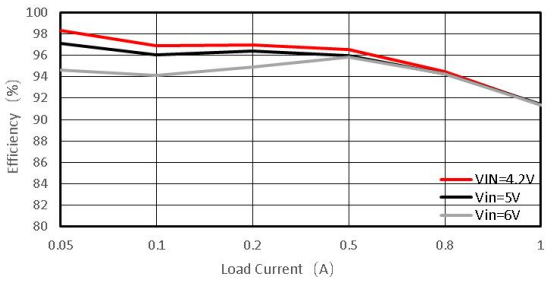
TYPICAL PERFORMANCE CHARACTERISTICS

VIN =5V, TA = +25ºC, unless otherwise noted.

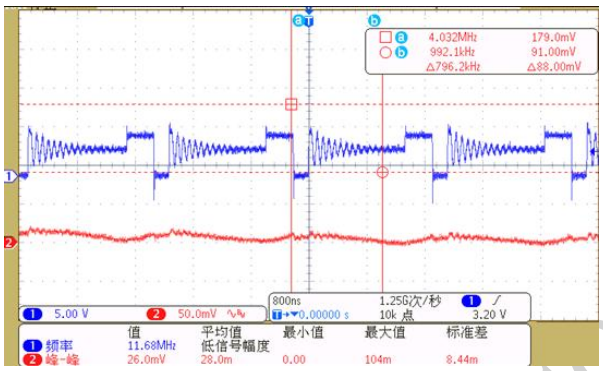
Load Regulation @ V_{OUT}=3.3V



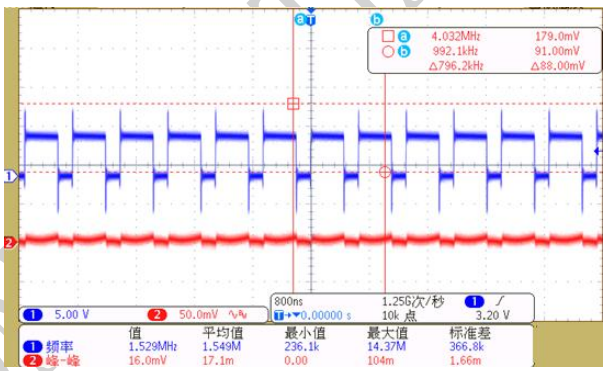
Efficiency @ V_{OUT}=3.3V



Output Ripple Voltage @ V_{OUT}=3.3V,I_{OUT}=0.05A

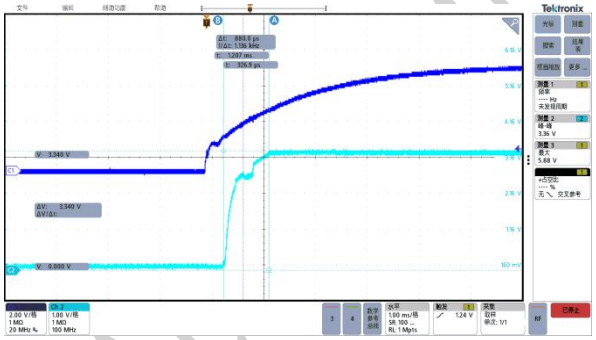


Output Ripple Voltage @ V_{OUT}=3.3V,I_{OUT}=0.8A



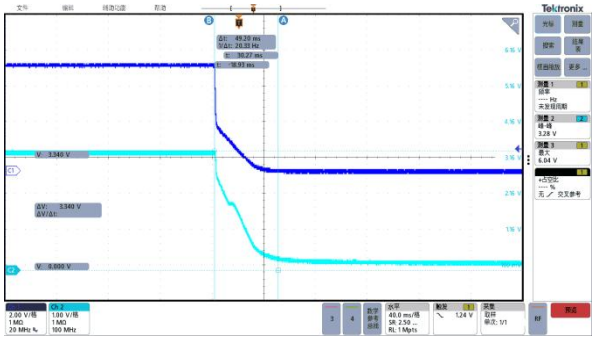
Startup from Vin

Vin=6V，Rcs=0.1Ω，Load=1 LED

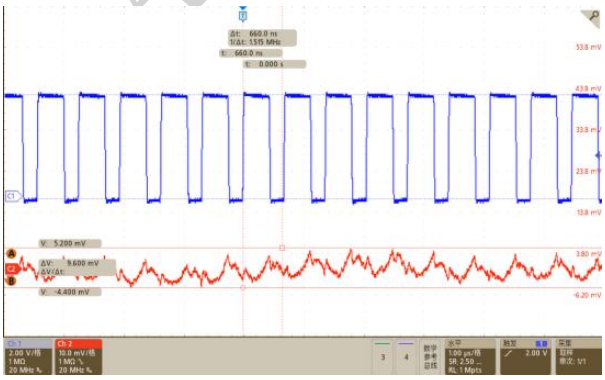


Shutdown from Vin

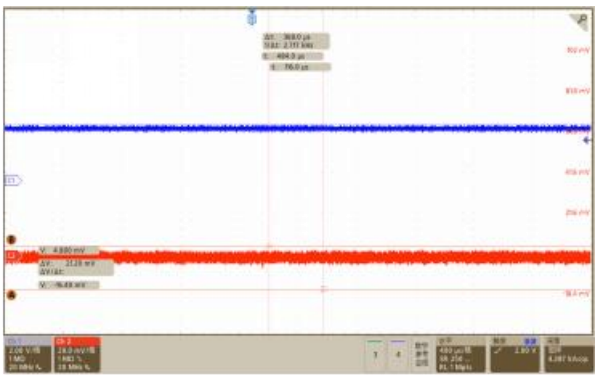
Vin=6V，Rcs=0.1Ω，Load=1 LED



LED 1S3P VIN=5V Rcs=0.210Ω



LED 1S3P VIN=2.5V Rcs=0.210Ω，100% duty cycle



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FUNCTIONAL BLOCK DIAGRAM

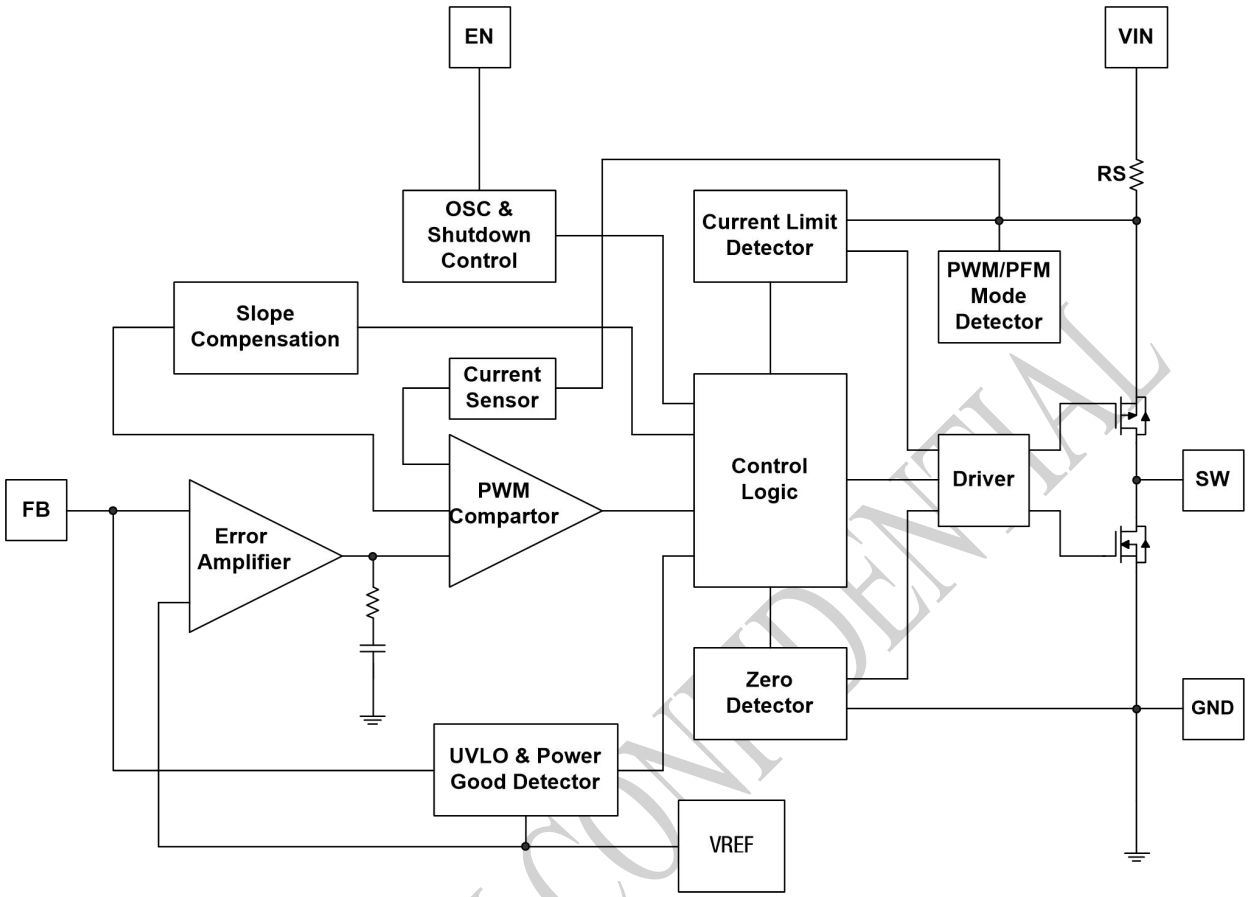


Figure 2. MT3401 Block Diagram

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FUNCTIONAL DESCRIPTION

The MT3401 is a high performance, 1A, 1.5MHz monolithic step-down LED Driver. The MT3401 requires only three external power components (C_{IN}, C_{OUT} and L). The LED driver current can be programmed with external feedback resistance between FB and GND pin up to 1.0A.

At dropout operation, the converter duty cycle increases to 100% and the output voltage tracks the input voltage minus the $R_{DS(ON)}$ drop of the high-side MOSFET.

The internal error amplifier and compensation provides excellent transient response, load, and line regulation. Soft start function prevents input inrush current and output overshoot during start up.

APPLICATIONS INFORMATION

Setting the I_{LED}

The internal reference V_{REF} is 0.1V (Typical).The I_{LED} is divided by a resistor, R1 to the FB pin. The I_{LED} is given by:

$$I_{LED}=V_{FB}/R1$$

Inductor Selection

For most designs, the MT3401 operates with inductors of 1μH to 4.7μH. Low inductance values are physically smaller but require faster switching, which results in some efficiency loss. The inductor value can be derived from the following equation:

$$L=\frac{V_{OUT}\times(V_{IN}-V_{OUT})}{V_{IN}\times\Delta I_L\times f_{OSC}}$$

Where ΔI_L is inductor Ripple Current. Large value inductors result in lower ripple current and small value inductors result in high ripple current. For optimum voltage-positioning load transients, choose an inductor with DC series resistance in the 50mΩ to 150mΩ range.

Input Capacitor Selection

The input capacitor reduces the surge current drawn from the input and switching noise from the device. The input capacitor impedance at the switching frequency should be less than input source impedance to prevent high frequency switching current passing to the input. A low ESR input capacitor sized for maximum RMS current must be used. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. A 10μF ceramic capacitor for most applications is sufficient. A large value may be used for improved input voltage filtering.

Output Capacitor Selection

The output capacitor is required to keep the output voltage ripple small and to ensure regulation loop stability. The output capacitor must have low impedance at the switching frequency. Ceramic capacitors with X5R or X7R dielectrics are recommended due to their low ESR and high ripple current ratings. The output ripple ΔV_{OUT} is determined by:

$$\Delta V_{OUT}\le\frac{V_{OUT}\times(V_{IN}-V_{OUT})}{V_{IN}\times f_{OSC}\times L}\times\left(ESR+\frac{1}{8\times f_{OSC}\times C_{OUT}}\right)$$

A 10μF ceramic can satisfy most applications.

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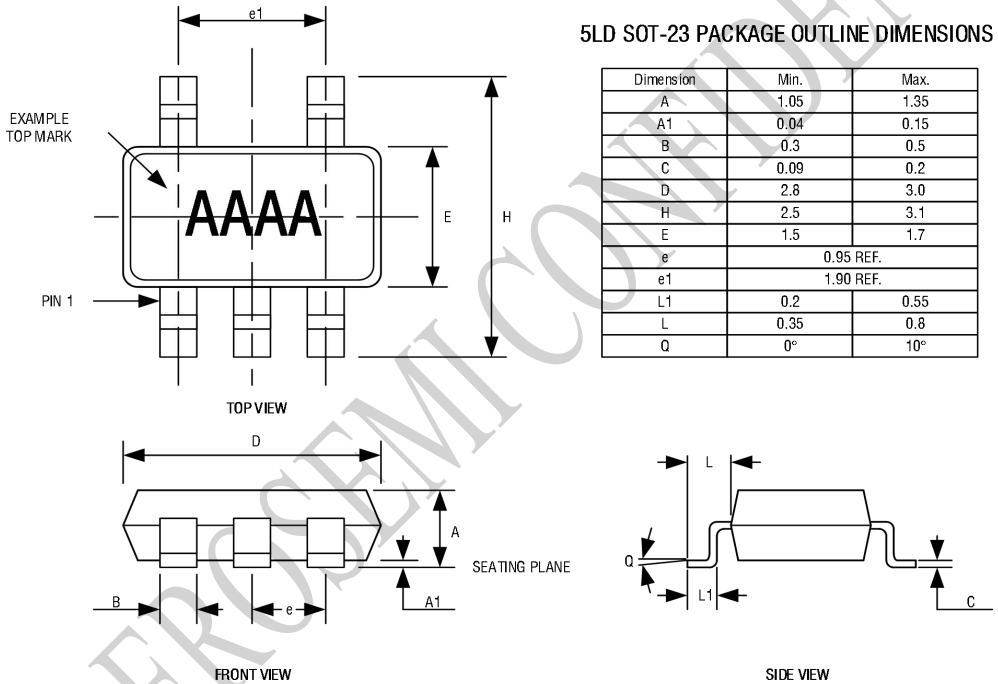
PCB Layout Recommendations

When laying out the printed circuit board, the following checking should be used to ensure proper operation of the MT3401. Check the following in your layout:

- Does the (+) plates of C_{IN} connect to VIN as closely as possible. This capacitor provides the AC current to the internal power MOSFETs.
- The power traces, consisting of the GND trace, the SW trace and the VIN trace should be kept short, direct, and wide.
- Keep the switching node, SW, away from the sensitive V_{OUT} node.
- Keep the (-) plates of C_{IN} and C_{OUT} as close as possible.

PACKAGE DESCRIPTION

SOT23-5



5LD SOT-23 PACKAGE OUTLINE DIMENSIONS

Dimension	Min.	Max.
A	1.05	1.35
A1	0.04	0.15
B	0.3	0.5
C	0.09	0.2
D	2.8	3.0
H	2.5	3.1
E	1.5	1.7
e	0.95 REF.	
e1	1.90 REF.	
L1	0.2	0.55
L	0.35	0.8
Q	0°	10°

NOTE:
1.DIMENSIONS ARE IN MILLIMETERS
2.DRAWING NOT TO SCALE
3.DIMENSIONS ARE INCLUSIVE OF PLATING
4.DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH AND METAL BURR

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